

SICW040N120H4-BP-VB Datasheet N-Channel 1200 V (D-S) SiC Power MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V)	120	00
R _{DS(on)} at 25 °C (Ω)	V _{GS} = 10 V	0.040
Q _g (nC)	10	1

FEATURES

- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)

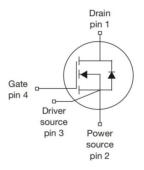
APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- DC/DC converter



TO-247-4L

- •Pin1 D Drain
- •Pin2 S Source(Power)
- •Pin3 S Source(Driver)
- •Pin4 G Gate



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)							
PARAMETER		SYMBOL	LIMIT	UNIT			
Drain-Source Voltage		V _{DS}	1200	V			
Gate-Source Voltage	V_{GS}	-10 / +22]				
Continuous Drain Current (T _J = 150 °C)	V_{GS} at 18 V $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 100 ^{\circ}\text{C}$	I _D	60				
	$T_C = 100 ^{\circ}C$		42	Α			
Pulsed Drain Current ^a	I _{DM}	160	1				
Linear Derating Factor			2.1	W/°C			
Single Pulse Avalanche Energy b		E _{AS}	1200	mJ			
Maximum Power Dissipation	P_{D}	320	W				
Operating Junction and Storage Temperature Range	e	T _J , T _{stg}	-55 to +175	°C			
Drain-Source Voltage Slope	T _J = 125 °C	al\	50	V/ns			
Reverse Diode dV/dt ^d	dV/dt	15	V/IIS				
Soldering Recommendations (Peak Temperature) c	for 10 s		260	°C			

- a. Repetitive rating; pulse width limited by maximum junction temperature. b. $V_{DD}=100$ V, starting $T_{J}=25$ °C, L = 30mH, $R_{g}=25$ Ω , $I_{AS}=9$ A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$.



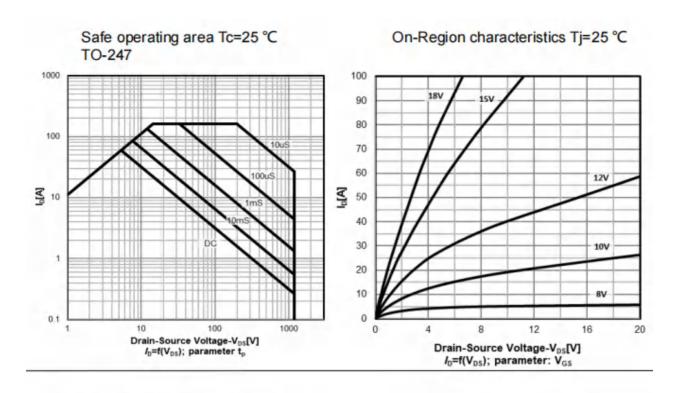
THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	40	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.47	C/VV

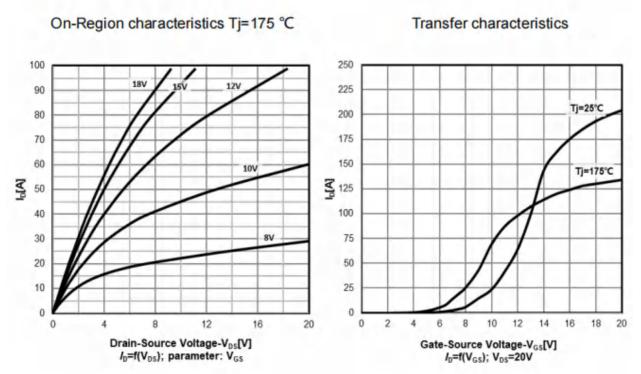
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 1 mA	1200	-	-	٧
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.70	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 10 mA	2.5	-	4.5	V
		,	V _{GS} = +22 V	-	-	100	nA
Gate-Source Leakage	I_{GSS}	,	V _{GS} = -10 V	-	-	100	μA
		V _{DS} =	= 1200 V, V _{GS} = 0 V	-	10	-	
Zero Gate Voltage Drain Current	I_{DSS}		V, V _{GS} = 0 V, T _J = 125 °C	-	-	100	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 18 V	I _D = 30A	-	0.040	-	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 0 V, I _D = 30 A	-	16	-	S
Dynamic				l.	l		
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	2200	-	
Output Capacitance	Coss		$V_{DS} = 800 \text{ V},$	-	123	-	1
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	10	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 800 V, V _{GS} = 0 V		-	156	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	268	-	
Total Gate Charge	Qg			-	101	-	
Gate-Source Charge	Q _{gs}	V _{GS} = -5/18 V	$I_D = 20 A, V_{DS} = 800 V$	-	29	-	nC
Gate-Drain Charge	Q_{gd}			-	33	-	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 800 \text{ V}, I_{D} = 20\text{A},$ $V_{GS} = -5/18 \text{ V}, R_{g} = 2 \Omega$		-	18	25	
Rise Time	t _r			-	24	55	ns
Turn-Off Delay Time	t _{d(off)}			-	80	-	
Fall Time	t _f			-	12	-	
Gate Input Resistance	R_{g}	f = 1 MHz, open drain		-	3.2	-	Ω
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	Is	MOSFET syml	MOSFET symbol showing the		-	60	
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	160	- A
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 30 A, V _{GS} = 0	-	-	4.1	V
Reverse Recovery Time	t _{rr}	-		_	47	-	ns
Reverse Recovery Charge	Q _{rr}	T _J = 25 °C, I _F = I _S = 30 A, dl/dt = 1000 A/µs, V _R = 800 V		_	220	_	μC
Reverse Recovery Current	I _{RRM}				60	_	A

Notes

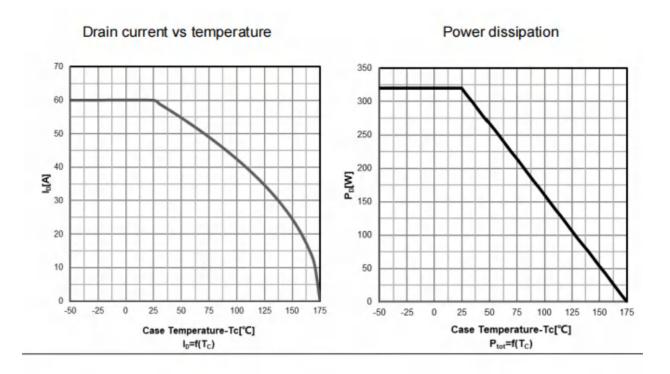
- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

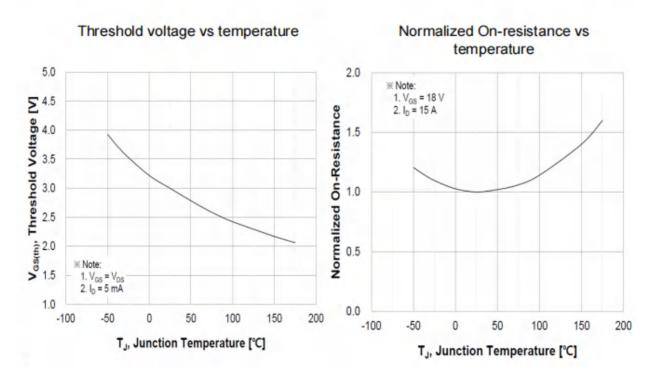




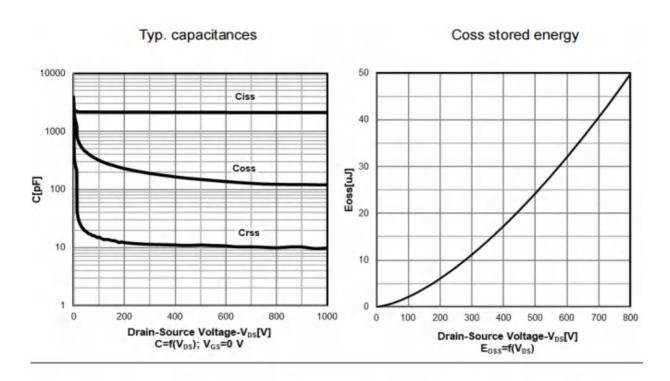


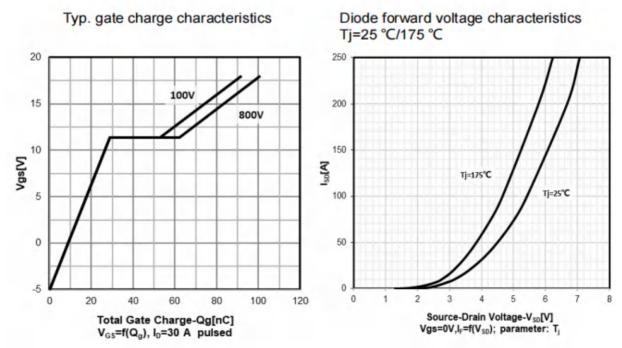








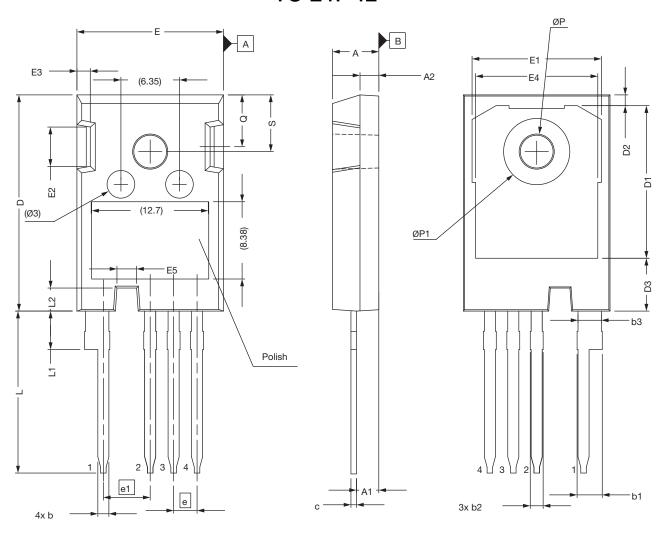




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DIM.	MILLIMETERS			
	MIN.	NOM.	MAX.	
Α	4.83	5.02	5.21	
A1	2.29	2.41	2.54	
A2	1.91	2.00	2.16	
b	1.07	1.20	1.33	
b1	2.39	2.67	2.94	
b2	1.07	1.30	1.60	
b3	2.39	2.53	2.69	
С	0.55	0.60	0.68	
D	23.30	23.45	23.60	
D1	16.25	16.55	17.65	
D2	0.95	1.19	1.25	
D3	5.55	5.71	6.01	
E	15.75	15.94	16.13	
E1	13.10	14.02	14.15	
E2	3.68	4.40	5.10	
E3	1.00	1.45	1.90	
E4	12.38	13.26	13.43	
E5	1.95	2.15	2.35	
е		2.54 BSC.		
e1	5.08 BSC.			
L	17.31	17.57	17.82	
L1	3.97	4.19	4.37	
L2	2.35	2.50	2.65	
ØP	3.51	3.61	3.65	
ØP1		7.19 ref.		
Q	5.49	5.79	6.00	
S	6.04	6.17	6.30	

Notes

- All dimensions are in mm
 Dimension D and E do not include mold flash.
 Creepage 1 is 8.40 mm (ref.) which is the distance alongside the surface between drain (pin 1) and trough the notch towards source (pin 2).
 Creepage 2 is 7.70 mm (ref.) which is the distance from end of the copper slug on the backside of the package to either pin 2, pin 3 or pin 4



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